

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	16	(("5103367") or ("5117121") or ("5325261") or ("5444597") or ("5452177") or ("5583736") or ("5810933") or ("5838529") or ("5916689") or ("5958813") or ("6117246") or ("6149774") or ("6215643") or ("6236555") or ("6378600") or ("6388861")).PN.	USPAT; USOCR	OR	OFF	2005/02/04 09:52
S2	6461	electro\$1static adj3 chuck	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 11:22
S3	874051	clamp\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:05
S4	38661	mem or micro\$electro\$1mechanical	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 11:25
S5	22	(electro\$1static adj3 chuck) and clamp\$4 and (mem or micro\$electro\$1mechanical)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 10:36
S6	71789	(method or process) with (chuck or clamp\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 10:37
S7	276340	electro\$1static	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:05
S8	4226	((method or process) with (chuck or clamp\$4)) and electro\$1static	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 10:38
S9	2609	(((method or process) with (chuck or clamp\$4)) and electro\$1static) and (electro\$1static adj3 chuck)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 10:38

S10	2972460	semiconductor or si or silicon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 17:15
S11	2146	((((method or process) with (chuck or clamp\$4)) and electro\$1static) and (electro\$1static adj3 chuck)) and (semiconductor or si or silicon)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 10:40
S12	115965	chuck or susceptor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:03
S13	8647	electro\$1static and (chuck or susceptor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 11:24
S14	145	(electro\$1static and (chuck or susceptor)) and (mem or micro\$electro\$1mechanical)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 11:24
S15	57413	mem or micro\$electro\$1mechanical or micro\$1mechanical\$2 or micro\$1machin\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/04 09:51
S16	408	(electro\$1static and (chuck or susceptor)) and (mem or micro\$electro\$1mechanical or micro\$1mechanical\$2 or micro\$1machin\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 11:26
S17	100	((electro\$1static and (chuck or susceptor)) and (mem or micro\$electro\$1mechanical or micro\$1mechanical\$2 or micro\$1machin\$4)) and clamp\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 11:42
S18	4924	(438/758 or 438/761 or 438/763 or 438/778 or 438/800).ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 11:46
S19	502	((438/758 or 438/761 or 438/763 or 438/778 or 438/800).ccls.) and (chuck or susceptor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 11:46

S20	10	((438/758 or 438/761 or 438/763 or 438/778 or 438/800).ccls.) and (chuck or susceptor) and (mem or micro\$electro\$1mechanical or micro\$1mechanical\$2 or micro\$1machin\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 11:46
S21	29122	(multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:01
S22	137322	multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:03
S23	162031	((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 17:17
S24	184113	chuck or susceptor or ((wafer or substrate) near4 hold\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:04
S25	280919	(chuck or susceptor or ((wafer or substrate) near4 hold\$4)) or platen	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:05
S26	3773	(((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6)) and ((chuck or susceptor or ((wafer or substrate) near4 hold\$4)) or platen)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:05
S27	874051	clamp\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:05
S28	895	((((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6)) and ((chuck or susceptor or ((wafer or substrate) near4 hold\$4)) or platen)) and clamp\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:05

S29	276340	electro\$1static	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:06
S30	435	(((((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6)) and ((chuck or susceptor or ((wafer or substrate) near4 hold\$4)) or platen)) and clamp\$4) and electro\$1static	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:06
S31	136328	mem or micro\$electro\$1mechanical or micro\$1mechanical\$2 or micro\$1machin\$4 or electro\$1mechanical\$2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:07
S32	84	(((((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6)) and ((chuck or susceptor or ((wafer or substrate) near4 hold\$4)) or platen)) and clamp\$4) and electro\$1static) and (mem or micro\$electro\$1mechanical or micro\$1mechanical\$2 or micro\$1machin\$4 or electro\$1mechanical\$2)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:31
S33	351	(((((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6)) and ((chuck or susceptor or ((wafer or substrate) near4 hold\$4)) or platen)) and clamp\$4) and electro\$1static) not ((((((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6)) and ((chuck or susceptor or ((wafer or substrate) near4 hold\$4)) or platen)) and clamp\$4) and electro\$1static) and (mem or micro\$electro\$1mechanical or micro\$1mechanical\$2 or micro\$1machin\$4 or electro\$1mechanical\$2)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:32

S34	2055579	protru\$6 or stud\$4 or island or pedestal or column	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 14:33
S35	199	(((((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6)) and ((chuck or susceptor or ((wafer or substrate) near4 hold\$4)) or platen)) and clamp\$4) and electro\$1static) not (((((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6)) and ((chuck or susceptor or ((wafer or substrate) near4 hold\$4)) or platen)) and clamp\$4) and electro\$1static) and (mem or micro\$electro\$1mechanical or micro\$1mechanical\$2 or micro\$1machin\$4 or electro\$1mechanical\$2))) and (protru\$6 or stud\$4 or island or pedestal or column)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 15:16
S36	2	("5572398").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/22 15:26
S37	2972460	semiconductor or si or silicon	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 17:15
S38	31118	(semiconductor or si or silicon) adj3 (platform or base)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 17:16
S39	1352	((semiconductor or si or silicon) adj3 (platform or base)) and clamp\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 17:17

S40	283	((semiconductor or si or silicon) adj3 (platform or base)) and clamp\$4) and (chuck or susceptor or ((wafer or substrate) near4 hold\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 17:21
S41	29	(((semiconductor or si or silicon) adj3 (platform or base)) and clamp\$4) and (chuck or susceptor or ((wafer or substrate) near4 hold\$4))) and (((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6 or dualpol\$6 or doublepol\$6) or (multiplepol\$6))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 17:17
S42	93	(((semiconductor or si or silicon) adj3 (platform or base)) and clamp\$4) and (chuck or susceptor or ((wafer or substrate) near4 hold\$4))) and electro\$1static	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 17:22
S43	78	((((semiconductor or si or silicon) adj3 (platform or base)) and clamp\$4) and (chuck or susceptor or ((wafer or substrate) near4 hold\$4))) and electro\$1static) not (((semiconductor or si or silicon) adj3 (platform or base)) and clamp\$4) and (chuck or susceptor or ((wafer or substrate) near4 hold\$4))) and (((multi or multipl\$6 or bi or dual or double) adj2 (pole or polar\$5)) or (multipol\$6 or bipol\$6.or dualpol\$6 or doublepol\$6) or (multiplepol\$6))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/22 17:22
S48	61691	mem or micro\$electro\$1mechanical or micro\$1mechanical\$2 or micro\$1machin\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/04 09:51
S49	16	("5103367") or ("5117121") or ("5325261") or ("5444597") or ("5452177") or ("5583736") or ("5810933") or ("5838529") or ("5916689") or ("5958813") or ("6117246") or ("6149774") or ("6215643") or ("6236555") or ("6378600") or ("6388861")).PN.	USPAT; USOCR	OR	OFF	2005/02/04 09:52
S50	1	S48 and S49	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/04 09:53